Voltage Regulator - Adjustable Output, Positive

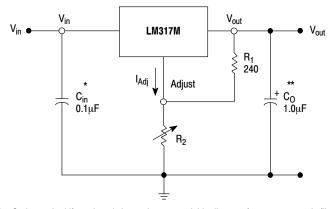
500 mA

The LM317M is an adjustable three-terminal positive voltage regulator capable of supplying in excess of 500 mA over an output voltage range of 1.2 V to 37 V. This voltage regulator is exceptionally easy to use and requires only two external resistors to set the output voltage. Further, it employs internal current limiting, thermal shutdown and safe area compensation, making it essentially blow-out proof.

The LM317M serves a wide variety of applications including local, on-card regulation. This device also makes an especially simple adjustable switching regulator, a programmable output regulator, or by connecting a fixed resistor between the adjustment and output, the LM317M can be used as a precision current regulator.

Features

- Output Current in Excess of 500 mA
- Output Adjustable between 1.2 V and 37 V
- Internal Thermal Overload Protection
- Internal Short Circuit Current Limiting
- Output Transistor Safe-Area Compensation
- Floating Operation for High Voltage Applications
- Eliminates Stocking Many Fixed Voltages
- NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These are Pb-Free Devices



 * = C_{in} is required if regulator is located an appreciable distance from power supply filter. ** = C_{O} is not needed for stability, however, it does improve transient response.

$$V_{out} = 1.25 V \left(1 + \frac{R_2}{R_1} \right) + I_{Adj} R_2$$

Since I_{Adj} is controlled to less than 100 μ A, the error associated with this term is negligible in most applications.

Figure 1. Simplified Application

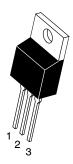


ON Semiconductor®

www.onsemi.com

Heatsink surface connected to Pin 2

TO-220AB T SUFFIX CASE 221AB



SOT-223 ST SUFFIX CASE 318E



DPAK DT SUFFIX CASE 369C



Heatsink Surface (shown as terminal 4 in case outline drawing) is connected to Pin 2.

PIN ASSIGNMENT		
1	Adjust	
2	V_{out}	
3	V_{in}	

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 10 of this data sheet.

DEVICE MARKING INFORMATION

See general marking information in the device marking section on page 11 of this data sheet.

MAXIMUM RATINGS (T_A = 25°C, unless otherwise noted.)

Rating	Symbol	Value	Unit
Input-Output Voltage Differential	$V_I - V_O$	40	Vdc
Power Dissipation (Package Limitation) (Note 1)			
Plastic Package, T Suffix, Case 221A			
$T_A = 25^{\circ}C$	P_{D}	Internally Limited	
Thermal Resistance, Junction-to-Air	$\theta_{\sf JA}$	70	°C/W
Thermal Resistance, Junction-to-Case	$\theta_{\sf JC}$	5.0	°C/W
Plastic Package, DT Suffix, Case 369C			
$T_A = 25^{\circ}C$	P_{D}	Internally Limited	
Thermal Resistance, Junction-to-Air	$\theta_{\sf JA}$	92	°C/W
Thermal Resistance, Junction-to-Case	$\theta_{\sf JC}$	5.0	°C/W
Plastic Package, ST Suffix, Case 318E			
$T_A = 25^{\circ}C$	P_{D}	Internally Limited	
Thermal Resistance, Junction-to-Air	$\theta_{\sf JA}$	245	°C/W
Thermal Resistance, Junction-to-Case	θ JC	15	°C/W
Maximum Junction Temperature		+150	°C
Storage Temperature Range	T _{stg}	-65 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

ELECTRICAL CHARACTERISTICS ($V_I - V_O = 5.0 \text{ V}$; $I_O = 0.1 \text{ A}$, $T_J = T_{low}$ to T_{high} (Note 2), unless otherwise noted.)

			LM317M/	LM317MB/NO	CV317MB	
Characteristics	Figure	Symbol	Min	Тур	Max	Unit
Line Regulation (Note 3) ($T_A = 25^{\circ}C$, 3.0 V \leq V _I $-$ V _O \leq 40 V)	3	Reg _{line}	-	0.01	0.04	%/V
Load Regulation (Note 3) $T_A = 25^{\circ}C, \ 10 \ \text{mA} \le I_O \le 0.5 \ \text{A}$ $V_O \le 5.0 \ \text{V}$	4	Reg _{load}	-	5.0	25	mV
V _O ≥ 5.0 V			ı	0.1	0.5	% V _O
Adjustment Pin Current	5	I_{Adj}	-	50	100	μΑ
Adjustment Pin Current Change $2.5~V \le V_I - V_O \le 40~V,~10~mA \le I_L \le 0.5~A,~P_D \le P_{max}$	3, 4	ΔI_{Adj}	-	0.2	5.0	μΑ
Reference Voltage 3.0 V \leq V _I $-$ V _O \leq 40 V, 10 mA \leq I _L \leq 0.5 A, P _D \leq P _{max}	5	V _{ref}	1.20	1.25	1.30	V
Line Regulation 3.0 V ≤ V _I –V _O ≤ 40 V (Note 3)	3	Reg _{line}	_	0.02	0.07	%/V
Load Regulation 10 mA \leq I $_{O} \leq$ 0.5 A (Note 3) $V_{O} \leq$ 5.0 V $V_{O} \geq$ 5.0 V	4	Reg _{load}	- -	20 0.3	70 1.5	mV % V _O
Temperature Stability $(T_{low} \le T_J \le T_{high})$	5	T _S	_	0.7	-	% Vo
Minimum Load Current to Maintain Regulation (V _I - V _O = 40 V)	5	I _{Lmin}	_	3.5	10	mA
$\begin{aligned} & \text{Maximum Output Current} \\ & \text{V}_I - \text{V}_O \leq 15 \text{ V}, \text{ P}_D \leq \text{P}_{\text{max}} \\ & \text{V}_I - \text{V}_O = 40 \text{ V}, \text{P}_D \leq \text{P}_{\text{max}}, \text{T}_A = 25^{\circ}\text{C} \end{aligned}$	5	I _{max}	0.5 0.15	0.9 0.25	- -	A
RMS Noise, % of V_O ($T_A = 25^{\circ}C$, 10 Hz $\leq f \leq$ 10 kHz)	-	N	=	0.003	-	% V _O
Ripple Rejection, V_O = 10 V, f = 120 Hz (Note 4) Without C_{Adj} C_{Adj} = 10 μF	6	RR	- 66	65 80	- -	dB
Thermal Shutdown (Note 5)	_	-	ı	180		°C
Long-Term Stability, T _J = T _{high} (Note 6) T _A = 25°C for End-point Measurements	5	S	-	0.3	1.0	%/1.0 kHrs.

^{1.} Figure 25 provides thermal resistance versus PC board pad size.

T_{low} to T_{high} = 0° to +125°C for LM317M
 T_{low} to T_{high} = -40° to +125°C for LM317MB, NCV317MB.
 Load and line regulation are specified at constant junction temperature. Changes in V_O due to heating effects must be taken into account separately. Pulse testing with low duty cycle is used.

^{4.} C_{Adj}, when used, is connected between the adjustment pin and ground.

^{5.} Thermal characteristics are not subject to production test.

^{6.} Since Long-Term Stability cannot be measured on each device before shipment, this specification is an engineering estimate of average stability from lot-to-lot.

ELECTRICAL CHARACTERISTICS ($V_I - V_O = 5.0 \text{ V}$; $I_O = 0.1 \text{ A}$, $T_J = T_{low}$ to T_{high} (Note 7), unless otherwise noted.)

			LM317MA/	LM317MAB/N	CV317MAB	
Characteristics	Figure	Symbol	Min	Тур	Max	Unit
Line Regulation (Note 8) ($T_A = 25^{\circ}C$, 3.0 $V \le V_I - V_O \le 40 \text{ V}$)	3	Reg _{line}	-	0.01	0.04	%/V
Load Regulation (Note 8) $T_A = 25^{\circ}\text{C}, \ 10 \text{ mA} \le I_O \le 0.5 \text{ A}$ $V_O \le 5.0 \text{ V}$ $V_O \ge 5.0 \text{ V}$	4	Reg _{load}	- -	5.0 0.1	25 0.5	mV % V _O
Adjustment Pin Current	5	I _{Adj}	-	50	100	μΑ
Adjustment Pin Current Change $2.5 \text{ V} \le \text{V}_{I} - \text{V}_{O} \le 40 \text{ V}$, $10 \text{ mA} \le \text{I}_{L} \le 0.5 \text{ A}$, $P_{D} \le P_{max}$	3, 4	ΔI_{Adj}	-	0.2	5.0	μΑ
Reference Voltage 3.0 V \leq V _I $-$ V _O \leq 40 V, 10 mA \leq I _L \leq 0.5 A, P _D \leq P _{max}	5	V _{ref}	1.225	1.250	1.275	V
Line Regulation (Note 8) 3.0 $V \le V_I - V_O \le 40 \text{ V}$	3	Reg _{line}	-	0.02	0.07	%/V
Load Regulation (Note 8) 10 mA \leq I $_{O} \leq$ 0.5 A $V_{O} \leq$ 5.0 V $V_{O} \geq$ 5.0 V	4	Reg _{load}	- -	20 0.3	70 1.5	mV % V _O
Temperature Stability $(T_{low} \le T_J \le T_{high})$	5	T _S	-	0.7	-	% Vo
Minimum Load Current to Maintain Regulation (V _I – V _O = 40 V)	5	I _{Lmin}	-	3.5	10	mA
Maximum Output Current $ V_I - V_O \le 15 \text{ V}, P_D \le P_{max} $ $ V_I - V_O = 40 \text{ V}, P_D \le P_{max}, T_A = 25^{\circ}\text{C} $	5	I _{max}	0.5 0.15	0.9 0.25	- -	А
RMS Noise, % of V_O ($T_A = 25$ °C, 10 Hz \leq f \leq 10 kHz)	_	N	-	-	_	% Vo
Ripple Rejection, $V_O = 10 \text{ V}$, $f = 120 \text{ Hz}$ (Note 9) Without C_{Adj} $C_{Adj} = 10 \mu F$	6	RR	_ 66	65 80	- -	dB
Thermal Shutdown (Note 10) Long-Term Stability, $T_J = T_{high}$ (Note 11) $T_A = 25^{\circ}C$ for End-point Measurements	5	S	-	0.3	1.0	°C %/1.0 kHrs.

T_{low} to T_{high} = 0° to +125°C for LM317MA T_{low} to T_{high} = -40° to +125°C for LM317MAB, NCV317MAB.
 Load and line regulation are specified at constant junction temperature. Changes in V_O due to heating effects must be taken into account separately. Pulse testing with low duty cycle is used.
 C_{Adj}, when used, is connected between the adjustment pin and ground.
 Thermal characteristics are not subject to production test.

^{11.} Since Long-Term Stability cannot be measured on each device before shipment, this specification is an engineering estimate of average stability from lot-to-lot.

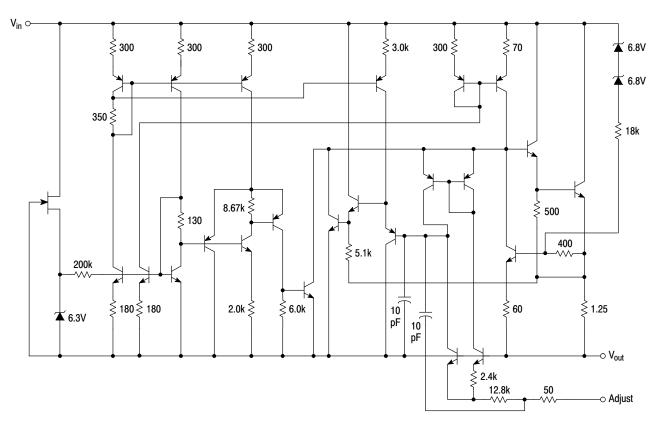


Figure 2. Representative Schematic Diagram

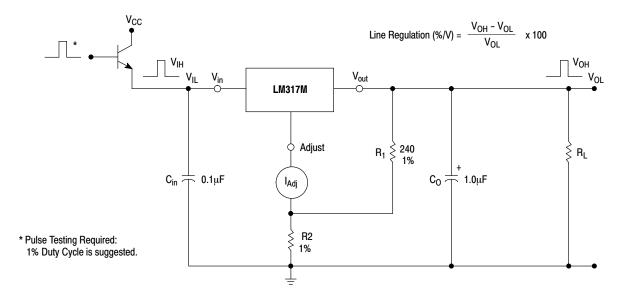
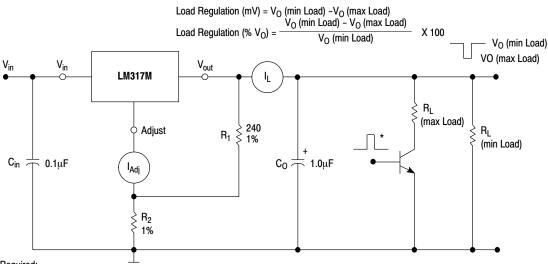


Figure 3. Line Regulation and $\Delta I_{\mbox{\scriptsize Adj}}/\mbox{\scriptsize Line}$ Test Circuit



* Pulse Testing Required: 1% Duty Cycle is suggested.

Figure 4. Load Regulation and $\Delta I_{\mbox{Adj}}/\mbox{Load Test Circuit}$

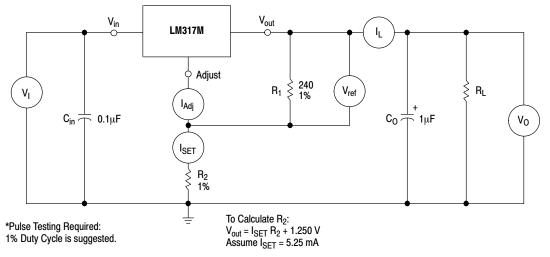


Figure 5. Standard Test Circuit

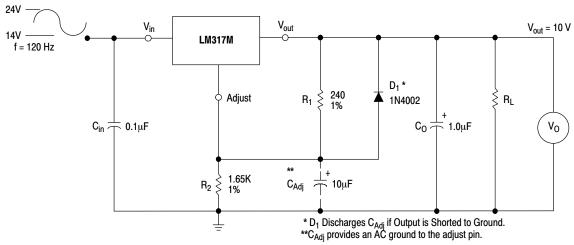


Figure 6. Ripple Rejection Test Circuit

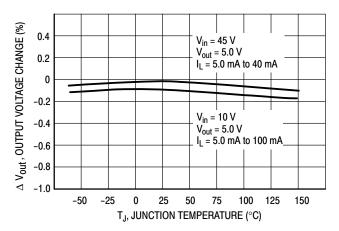


Figure 7. Load Regulation

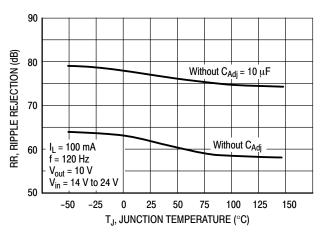


Figure 8. Ripple Rejection

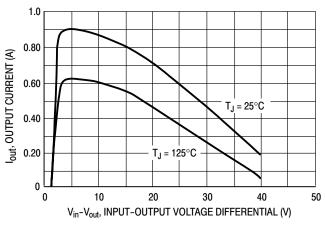


Figure 9. Current Limit

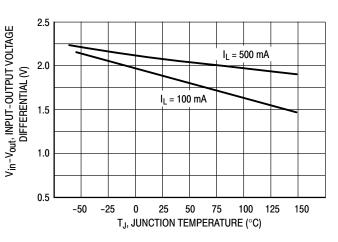


Figure 10. Dropout Voltage

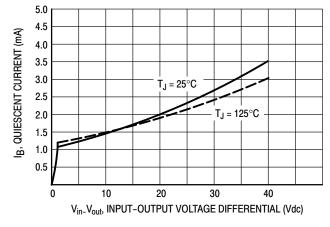


Figure 11. Minimum Operating Current

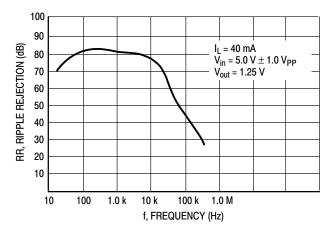


Figure 12. Ripple Rejection versus Frequency

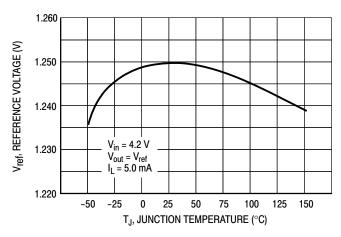


Figure 13. Temperature Stability

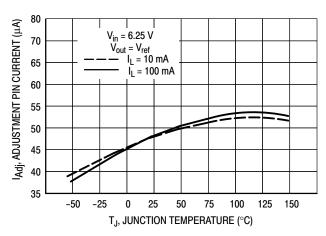


Figure 14. Adjustment Pin Current

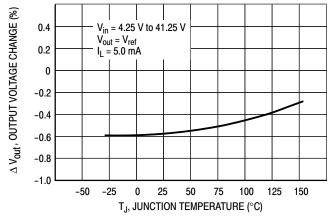


Figure 15. Line Regulation

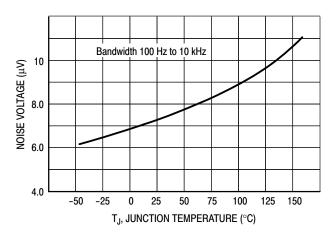


Figure 16. Output Noise

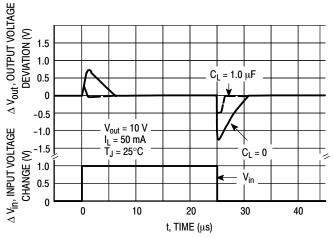


Figure 17. Line Transient Response

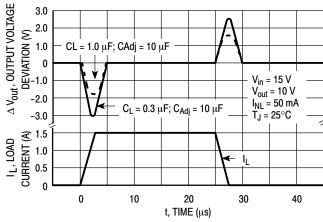


Figure 18. Load Transient Response

APPLICATIONS INFORMATION

Basic Circuit Operation

The LM317M is a three–terminal floating regulator. In operation, the LM317M develops and maintains a nominal 1.25 V reference (V_{ref}) between its output and adjustment terminals. This reference voltage is converted to a programming current (I_{PROG}) by R_1 (see Figure 19), and this constant current flows through R_2 to ground. The regulated output voltage is given by:

$$V_{out} = V_{ref} \left(1 + \frac{R_2}{R_1} \right) + I_{Adj} R_2$$

Since the current from the terminal (I_{Adj}) represents an error term in the equation, the LM317M was designed to control I_{Adj} to less than 100 μA and keep it constant. To do this, all quiescent operating current is returned to the output terminal. This imposes the requirement for a minimum load current. If the load current is less than this minimum, the output voltage will rise.

Since the LM317M is a floating regulator, it is only the voltage differential across the circuit which is important to performance, and operation at high voltages with respect to ground is possible.

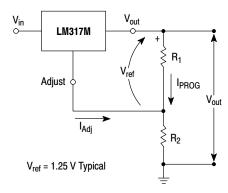


Figure 19. Basic Circuit Configuration

Load Regulation

The LM317M is capable of providing extremely good load regulation, but a few precautions are needed to obtain maximum performance. For best performance, the programming resistor (R_1) should be connected as close to the regulator as possible to minimize line drops which effectively appear in series with the reference, thereby degrading regulation. The ground end of R_2 can be returned near the load ground to provide remote ground sensing and improve load regulation.

External Capacitors

A $0.1\,\mu F$ disc or $1.0\,\mu F$ tantalum input bypass capacitor (C_{in}) is recommended to reduce the sensitivity to input line impedance.

The adjustment terminal may be bypassed to ground to improve ripple rejection. This capacitor (C_{Adj}) prevents ripple from being amplified as the output voltage is increased. A 10 μF capacitor should improve ripple rejection about 15 dB at 120 Hz in a 10 V application.

Although the LM317M is stable with no output capacitance, like any feedback circuit, certain values of external capacitance can cause excessive ringing. An output capacitance (C_O) in the form of a 1.0 μF tantalum or 25 μF aluminum electrolytic capacitor on the output swamps this effect and insures stability.

Protection Diodes

When external capacitors are used with any IC regulator it is sometimes necessary to add protection diodes to prevent the capacitors from discharging through low current points into the regulator.

Figure 20 shows the LM317M with the recommended protection diodes for output voltages in excess of 25 V or high capacitance values ($C_O > 25~\mu F$, $C_{Adj} > 5.0~\mu F$). Diode D_1 prevents C_O from discharging thru the IC during an input short circuit. Diode D_2 protects against capacitor C_{Adj} discharging through the IC during an output short circuit. The combination of diodes D_1 and D_2 prevents C_{Adj} from discharging through the IC during an input short circuit.

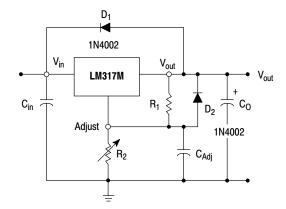


Figure 20. Voltage Regulator with Protection Diodes

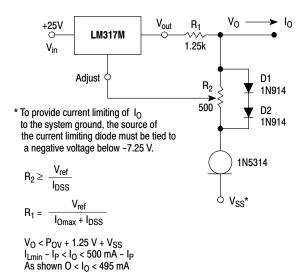
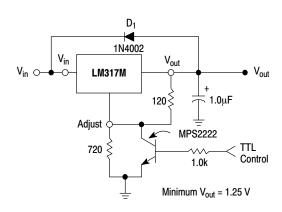


Figure 21. Adjustable Current Limiter



D₁ protects the device during an input short circuit.

Figure 22. 5 V Electronic Shutdown Regulator

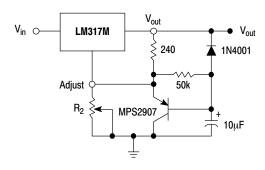


Figure 23. Slow Turn-On Regulator

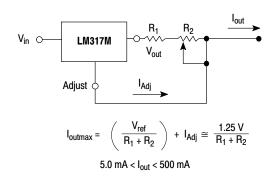


Figure 24. Current Regulator

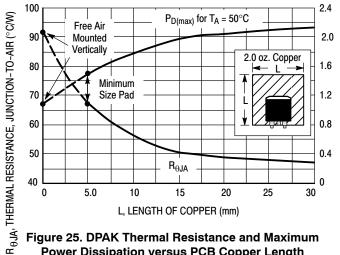


Figure 25. DPAK Thermal Resistance and Maximum **Power Dissipation versus PCB Copper Length**

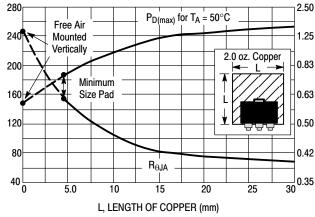


Figure 26. SOT-223 Thermal Resistance and Maximum **Power Dissipation versus PCB Copper Length**

ORDERING INFORMATION

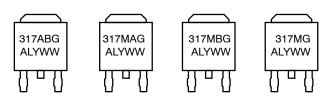
Device	Output Voltage Tolerance	Operating Temperature Range	Package	Shipping [†]
LM317MABDTG			DPAK (Pb-Free)	75 Units / Rail
LM317MABDTRKG			DPAK	2500 / Tape & Reel
NCV317MABDTRKG*		T _{.1} = -40°C to 125°C	(Pb-Free)	
NCV317MABSTT3G*	2%	., ., ., ., ., ., ., ., ., ., ., ., ., .	SOT-223 (Pb-Free)	4000 / Tape & Reel
LM317MABTG			TO-220 (Pb-Free)	50 Units / Rail
LM317MADTRKG	1	T _J = 0°C to 125°C	DPAK (Pb-Free)	2500 / Tape & Reel
LM317MBDTG			DPAK	75 Units / Rail
NCV317MBDTG*			(Pb-Free)	
LM317MBDTRKG			DPAK	2500 / Tape & Reel
NCV317MBDTRKG*		$T_J = -40^{\circ}\text{C} \text{ to } 125^{\circ}\text{C}$	(Pb-Free)	
LM317MBSTT3G			SOT-223	4000 / Tape & Reel
NCV317MBSTT3G*			(Pb-Free)	
LM317MBTG			TO-220	50 Units / Rail
NCV317MBTG*	4%		(Pb-Free)	
LM317MDTG			DPAK (Pb-Free)	75 Units / Rail
LM317MDTRKG		T 200 1 1070C	DPAK (Pb-Free)	2500 / Tape & Reel
LM317MSTT3G		T _J = 0°C to 125°C	SOT-223 (Pb-Free)	4000 / Tape & Reel
LM317MTG			TO-220 (Pb-Free)	50 Units / Rail

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

*NCV devices: T_{low} = -40°C, T_{high} = +125°C. Guaranteed by design. NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.

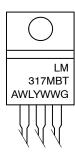
MARKING DIAGRAMS

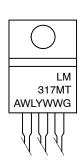
DPAK DT SUFFIX CASE 369C

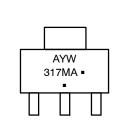


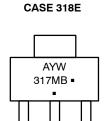






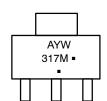






SOT-223

ST SUFFIX



A = Assembly Location

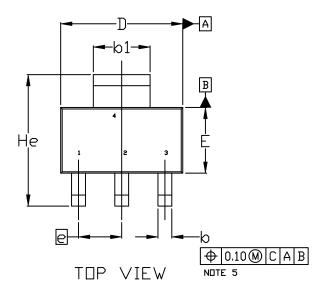
L, WL = Wafer Lot
Y = Year
WW, W = Work Week
G or ■ = Pb-Free Package

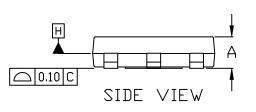
(Note: Microdot may be in either location)



SOT-223 (TO-261) CASE 318E-04 ISSUE R

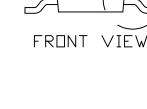
DATE 02 OCT 2018





DETAIL A

A1

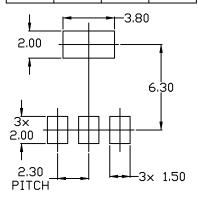


SEE DETAIL A

NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. DIMENSIONS D & E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
 MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.200MM PER SIDE.
- 4. DATUMS A AND B ARE DETERMINED AT DATUM H.
- 5. ALLIS DEFINED AS THE VERTICAL DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT OF THE PACKAGE BODY.
- 6. POSITIONAL TOLERANCE APPLIES TO DIMENSIONS 6 AND 61.

	MI	LLIMETE	RS
DIM	MIN.	N□M.	MAX.
Α	1.50	1.63	1.75
A1	0.02	0.06	0.10
b	0.60	0.75	0.89
b1	2.90	3.06	3.20
c	0.24	0.29	0.35
D	6.30	6.50	6.70
E	3.30	3.50	3.70
е		2.30 BSC	;
L	0.20		
L1	1.50	1.75	2.00
He	6.70	7.00	7.30
θ	0*		10°



RECOMMENDED MOUNTING FOOTPRINT

DOCUMENT NUMBER:	98ASB42680B	Electronic versions are uncontrolled except when accessed directly from Printed versions are uncontrolled except when stamped "CONTROLLED"	
DESCRIPTION:	SOT-223 (TO-261)		PAGE 1 OF 2

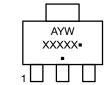
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SOT-223 (TO-261) CASE 318E-04 ISSUE R

DATE 02 OCT 2018

STYLE 1: PIN 1. BASE 2. COLLECTOR 3. EMITTER 4. COLLECTOR	STYLE 2: PIN 1. ANODE 2. CATHODE 3. NC 4. CATHODE	STYLE 3: PIN 1. GATE 2. DRAIN 3. SOURCE 4. DRAIN	STYLE 4: PIN 1. SOURCE 2. DRAIN 3. GATE 4. DRAIN	STYLE 5: PIN 1. DRAIN 2. GATE 3. SOURCE 4. GATE
STYLE 6: PIN 1. RETURN 2. INPUT 3. OUTPUT 4. INPUT	STYLE 7: PIN 1. ANODE 1 2. CATHODE 3. ANODE 2 4. CATHODE	STYLE 8: CANCELLED	STYLE 9: PIN 1. INPUT 2. GROUND 3. LOGIC 4. GROUND	STYLE 10: PIN 1. CATHODE 2. ANODE 3. GATE 4. ANODE
STYLE 11: PIN 1. MT 1 2. MT 2 3. GATE 4. MT 2	STYLE 12: PIN 1. INPUT 2. OUTPUT 3. NC 4. OUTPUT	STYLE 13: PIN 1. GATE 2. COLLECTOR 3. EMITTER 4. COLLECTOR		

GENERIC MARKING DIAGRAM*



A = Assembly Location

Y = Year W = Work Week

XXXXX = Specific Device Code

= Pb-Free Package

(Note: Microdot may be in either location)
*This information is generic. Please refer to
device data sheet for actual part marking.
Pb-Free indicator, "G" or microdot "•", may
or may not be present. Some products may
not follow the Generic Marking.

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DESCRIPTION:	SOT-223 (TO-261)		PAGE 2 OF 2

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MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS





TO-220, SINGLE GAUGE CASE 221AB-01 **ISSUE A**

DATE 16 NOV 2010

- NOTES:

 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

 2. CONTROLLING DIMENSION: INCHES.

 3. DIMENSION 2 DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARTIES ARE ALLOWED.

 4. PRODUCT SHIPPED PRIOR TO 2008 HAD DIMENSIONS S = 0.045 0.055 INCHES (1.143 1.397 MM)

	INC	INCHES		IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.570	0.620	14.48	15.75
В	0.380	0.405	9.66	10.28
С	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
Н	0.110	0.155	2.80	3.93
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.020	0.024	0.508	0.61
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
٧	0.045		1.15	
Z		0.080		2.04





STYLE 1: PIN 1. 2. 3. 4.	EMITTER	STYLE 2: PIN 1. 2. 3. 4.		STYLE 3: PIN 1. 2. 3. 4.	CATHODE ANODE GATE ANODE
STYLE 5: PIN 1. 2. 3. 4.	GATE DRAIN SOURCE DRAIN	STYLE 6: PIN 1. 2. 3. 4.	ANODE CATHODE ANODE CATHODE	STYLE 7: PIN 1. 2. 3. 4.	CATHODE ANODE CATHODE ANODE
STYLE 9: PIN 1. 2. 3. 4.	GATE COLLECTOR EMITTER COLLECTOR	STYLE 10: PIN 1. 2. 3. 4.		STYLE 11: PIN 1. 2. 3. 4.	DRAIN SOURCE GATE SOURCE

STYLE 4: PIN 1. 2. 3. 4.	MAIN TERMINAL 2
2. 3.	CATHODE ANODE EXTERNAL TRIP/DELAY ANODE

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DESCRIPTION:	TO-220, SINGLE GAUGE		PAGE 1 OF 1

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В

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L3

b2 e **DATE 21 JUL 2015**

DPAK (SINGLE GAUGE) CASE 369C **ISSUE F** SCALE 1:1

DETAIL A

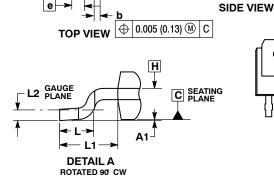
C-

NOTES:

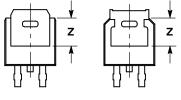
- IOTES: 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. 2. CONTROLLING DIMENSION: INCHES. 3. THERMAL PAD CONTOUR OPTIONAL WITHIN DI-
- MENSIONS b3, L3 and Z.
 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD
- FLASH, PROTRUSIONS, OR BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.006 INCHES PER SIDE.
 5. DIMENSIONS D AND E ARE DETERMINED AT THE
- OUTERMOST EXTREMES OF THE PLASTIC BODY.

 6. DATUMS A AND B ARE DETERMINED AT DATUM
- 7. OPTIONAL MOLD FEATURE.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.086	0.094	2.18	2.38
A1	0.000	0.005	0.00	0.13
b	0.025	0.035	0.63	0.89
b2	0.028	0.045	0.72	1.14
b3	0.180	0.215	4.57	5.46
С	0.018	0.024	0.46	0.61
c2	0.018	0.024	0.46	0.61
D	0.235	0.245	5.97	6.22
E	0.250	0.265	6.35	6.73
е	0.090 BSC		2.29 BSC	
Н	0.370	0.410	9.40	10.41
L	0.055	0.070	1.40	1.78
L1	0.114 REF		2.90 REF	
L2	0.020 BSC		0.51 BSC	
L3	0.035	0.050	0.89	1.27
L4		0.040		1.01
Z	0.155		3.93	



NOTE 7



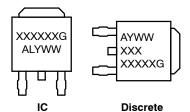
BOTTOM VIEW

BOTTOM VIEW ALTERNATE CONSTRUCTIONS

STYLE 1: PIN 1. BASE 2. COLLECTOR 3. EMITTER 4. COLLECTOR	STYLE 2:	STYLE 3:	STYLE 4:	STYLE 5:
	PIN 1. GATE	PIN 1. ANODE	PIN 1. CATHODE	PIN 1. GATE
	2. DRAIN	2. CATHODE	2. ANODE	2. ANODE
	3. SOURCE	3. ANODE	3. GATE	3. CATHODE
	4. DRAIN	4. CATHODE	4. ANODE	4. ANODE
4. COLLECTOR	4. DRAIN	4. CATHODE	4. ANODE	4. ANODE

STYLE 6:	STYLE 7:	STYLE 8:	STYLE 9:	STYLE 10:
PIN 1. MT1	PIN 1. GATE	PIN 1. N/C	PIN 1. ANODE	PIN 1. CATHODE
2. MT2	COLLECTOR	CATHODE	2. CATHODE	ANODE
3. GATE	EMITTER	ANODE	RESISTOR ADJUST	3. CATHODE
4. MT2	COLLECTOR	4. CATHODE	4. CATHODE	4. ANODE

GENERIC MARKING DIAGRAM*



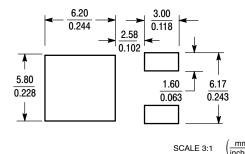
XXXXXX = Device Code = Assembly Location Α L = Wafer Lot Υ = Year WW = Work Week

G

*This information is generic. Please refer to device data sheet for actual part marking.

= Pb-Free Package

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DESCRIPTION:	DPAK (SINGLE GAUGE)		PAGE 1 OF 1

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